

# WCR420N65TF/TG

## 650V N-Channel Super Junction MOSFET

### Description

The WCR420N65 series is new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance. This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. This device is suitable for various AC/DC power conversion in switching mode operation for higher efficiency.

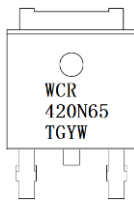
### Features

- 700V@T<sub>J</sub>=150° C
- Typ.RDS(on)=0.37Ω
- Low gate charge
- 100% avalanche tested
- 100% R<sub>g</sub> tested



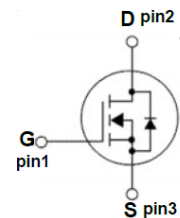
G D S

TO-220F



G D S

TO-252



### Order Information

Device	Package	Marking	Units/Tube	Units/Real
WCR420N65TF-3/T	TO-220F	WCR420N65TFYW <sup>(1)</sup>	50	
WCR420N65TG-3/TR	TO-252E-2L	WCR420N65TGYW <sup>(2)</sup>		2500

Note 1: WCR420N65TF=Device code ;Y=Year ;W=Week (A-z);

Note 2: WCR420N65TG=Device code ;Y=Year ;W=Week (A-z);

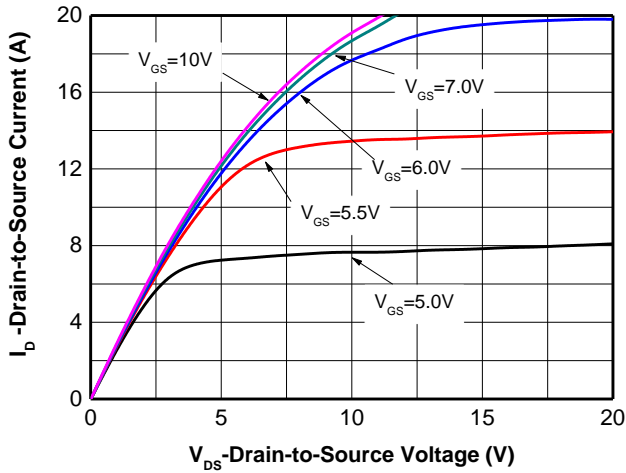
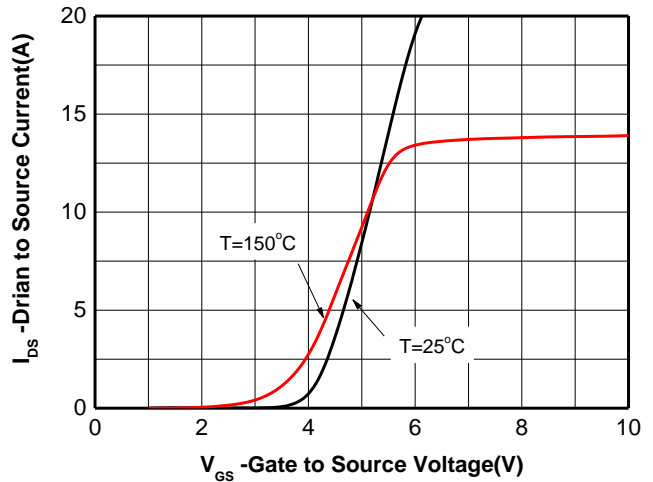
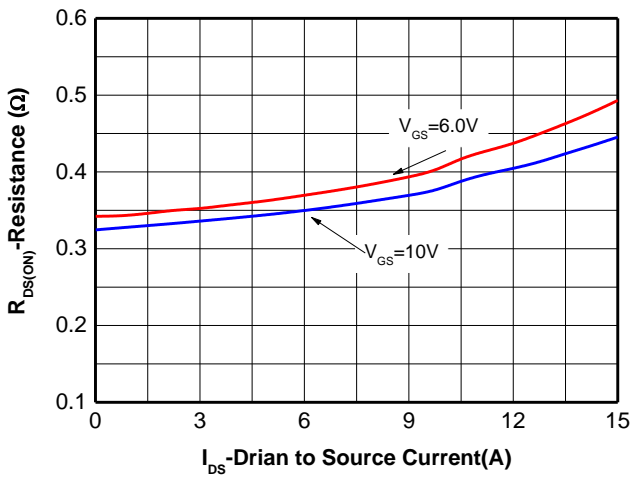
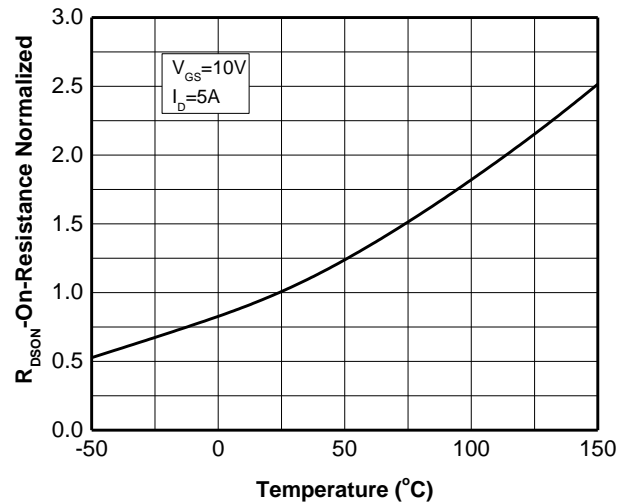
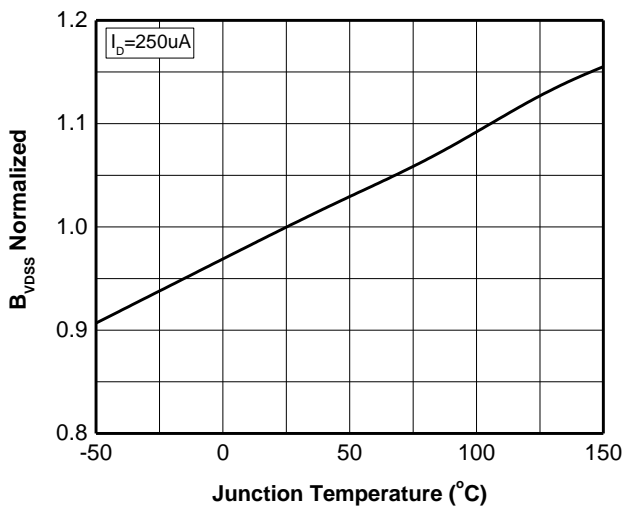
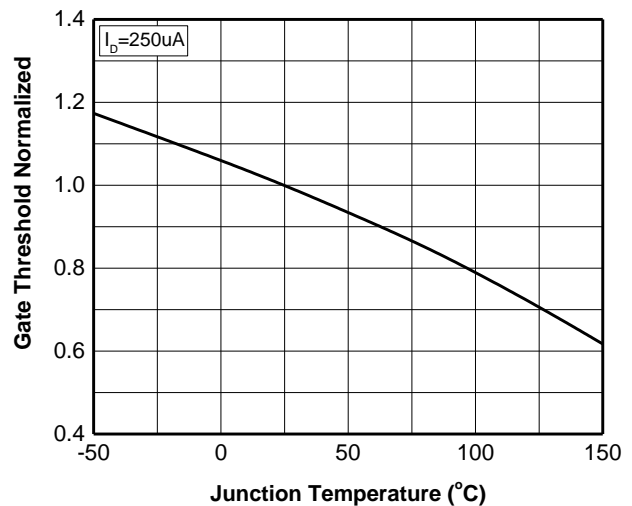
Absolusion Maximum Ratings T <sub>A</sub> =25°C unless otherwise noted				
Parameter	Symbol	WCR420N65TG	WCR420N65TF	Unit
Drain-Source Voltage	V <sub>DS</sub>	650		V
Gate-Source Voltage	V <sub>GS</sub>	±30		
Continuous Drain Current <sup>A</sup>	T <sub>C</sub> =25°C	10.2	5.8	A
	T <sub>C</sub> =100°C	6.4	3.7	
Pulsed Drain Current	I <sub>DM</sub>	41		A
Single Pulsed Avalanche Energy <sup>B</sup>	E <sub>AS</sub>	145		mJ
Power Dissipation	T <sub>C</sub> =25°C	96	31.2	W
	Derate above 25°C	0.76	0.25	W/°C
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55~150		°C
Lead Temperature	T <sub>L</sub>	260		°C
Thermal Resistance Ratings				
Maximum Junction-to-Ambient	R <sub>th(ch-A)</sub>	62 <sup>D</sup>	80	°C/W
Maximum Junction-to-Case	R <sub>th(ch-c)</sub>	1.3	4	

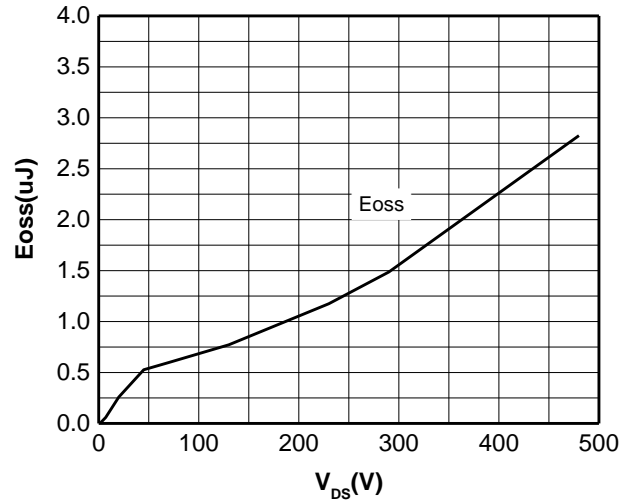
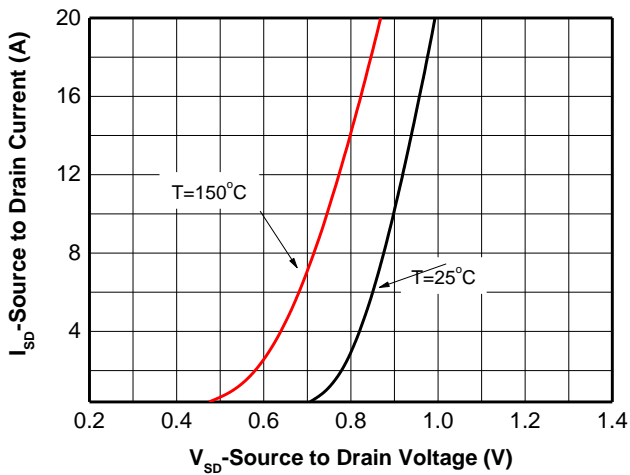
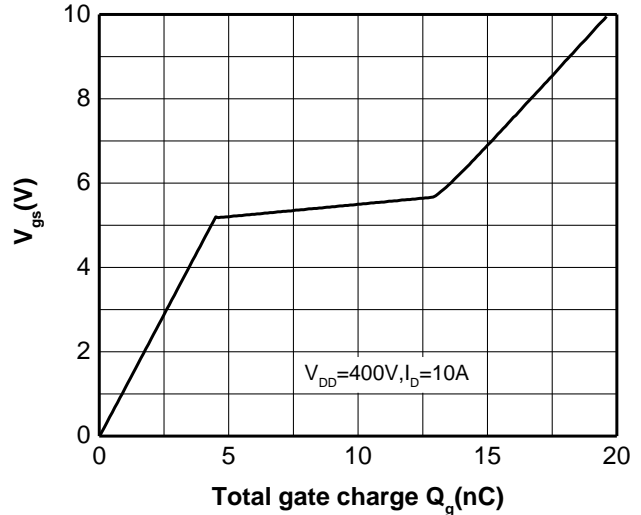
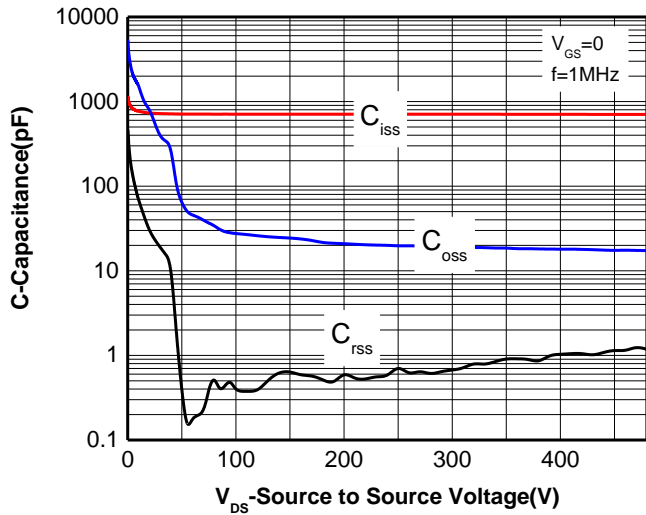
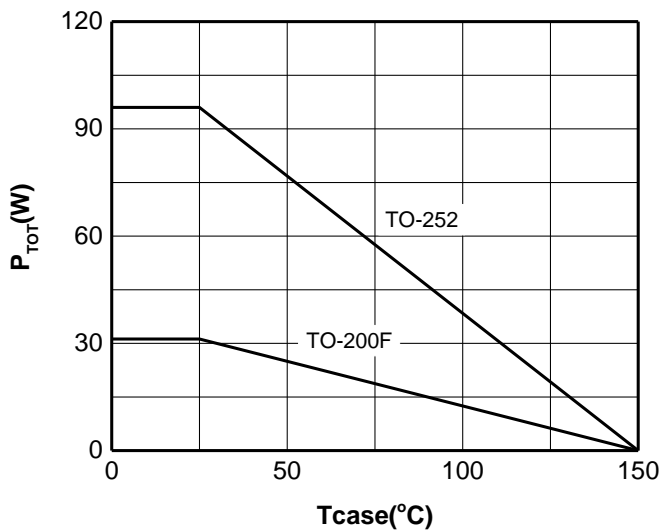
**Electronics Characteristics (T<sub>A</sub>=25°C, unless otherwise noted)**

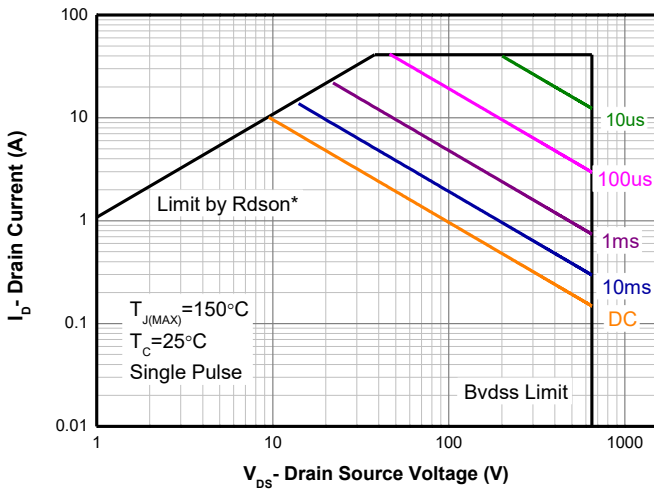
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>						
Drain-to-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250uA, T <sub>J</sub> =25°C	650			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =650V, V <sub>GS</sub> = 0V, T <sub>J</sub> =25°C			1	uA
Gate-to-source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±30V			±100	nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250uA	2	3	4	V
Drain-to-source On-resistance	R <sub>DS(on)</sub> <sup>C</sup>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 5A		0.37	0.42	Ω
<b>DYNAMIC PARAMETERS</b>						
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> = 0 V, f = 1.0 MHz, V <sub>DS</sub> = 400 V		705		pF
Output Capacitance	C <sub>OSS</sub>			18		
Reverse Transfer Capacitance	C <sub>RSS</sub>			1		
Total Gate Charge	Q <sub>G(TOT)</sub>	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 400 V, I <sub>D</sub> = 10A		19.5		nC
Gate-to-Source Charge	Q <sub>GS</sub>			4.5		
Gate-to-Drain Charge	Q <sub>GD</sub>			8.5		
Gate resistance	R <sub>g</sub>	V <sub>GS</sub> =0V , F=1MHZ, drain open		8.2		Ω
<b>SWITCHING CHARACTERISTICS</b>						
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 400 V, I <sub>D</sub> = 5A, R <sub>G</sub> =10 Ω		12.2		ns
Rise Time	t <sub>r</sub>			22.5		
Turn-Off Delay Time	t <sub>d(off)</sub>			40		
Fall Time	t <sub>f</sub>			19.5		
<b>Drain to Source Diode Characteristics and Maximum Ratings</b>						
Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 5A			1.5	V
Body-Diode Continuous Current	I <sub>S</sub>			10.2		A
Body-Diode Pulsed Current	I <sub>SM</sub>			41		A
Body Diode Reverse Recovery Time	T <sub>rr</sub>	I <sub>F</sub> =5A, di/dt=100A/us, V <sub>DS</sub> =400V		240		nS
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			1.74		uC
Peak reverse recovery Current	I <sub>rrm</sub>			14.5		A

**NOTES:**

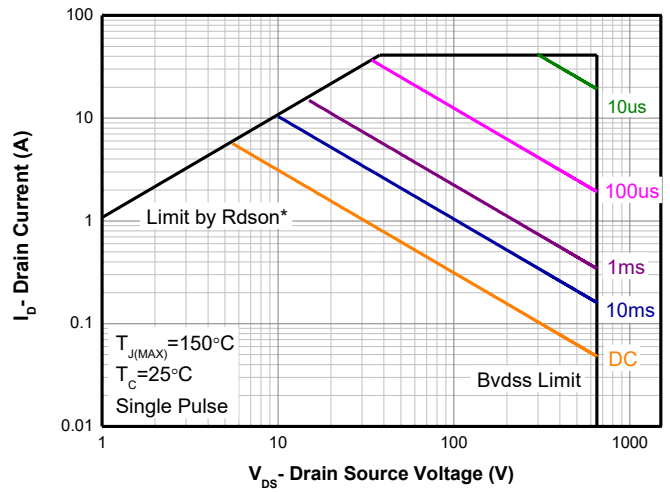
- Drain current limited by maximum junction temperature. Maximum duty cycle D=0.75
- L=100mH, I<sub>AS</sub>=1.7A, V<sub>DD</sub>=50V, Starting T<sub>J</sub>=25°C
- Pulse Test: Pulse width ≤300us, Duty Cycle ≤2% sensitively Independent of Operating Temperature Typical Characteristics
- These tests are performed with the device mounted on 1 in<sub>2</sub> FR-4 board with 2oz. Copper, in a still air environment with T<sub>A</sub>=25°C.

**Typical Characteristics ( $T_A=25^\circ\text{C}$ , unless otherwise noted)**

**Output characteristics**

**Transfer characteristics**

**On-Resistance vs. Drain current**

**On-Resistance vs. Junction temperature**

**Breakdown Voltage vs. Junction temperature**

**Threshold voltage vs. Junction temperature**

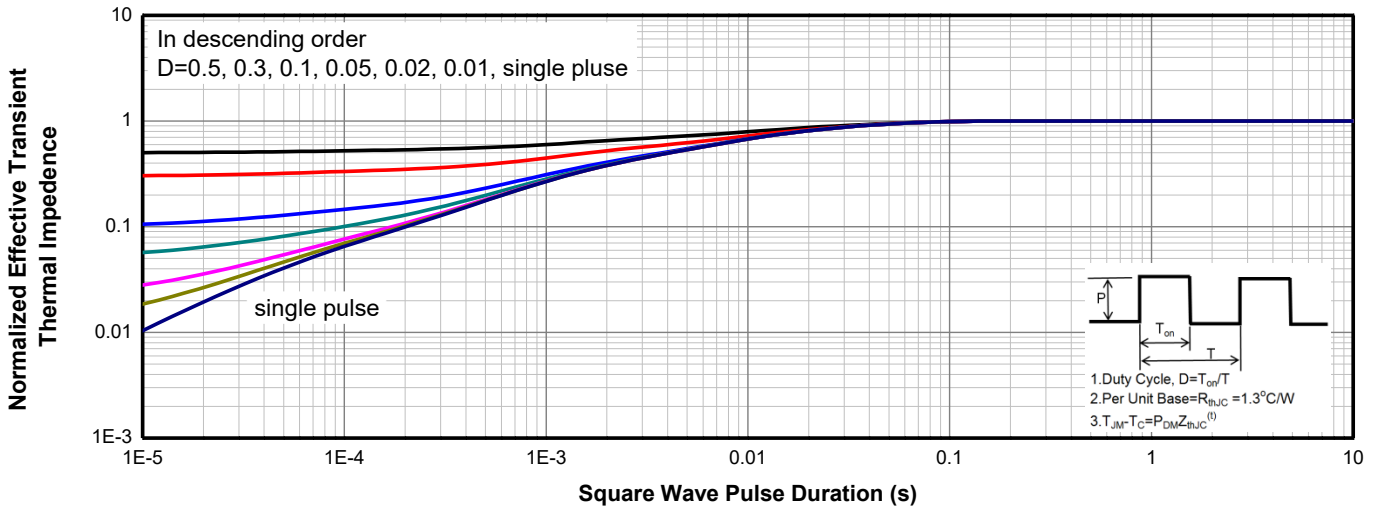

**Body diode forward voltage**
**Cosstored Energy**

**Capacitance**
**Gate charge Characteristics**

**Power dissipation**



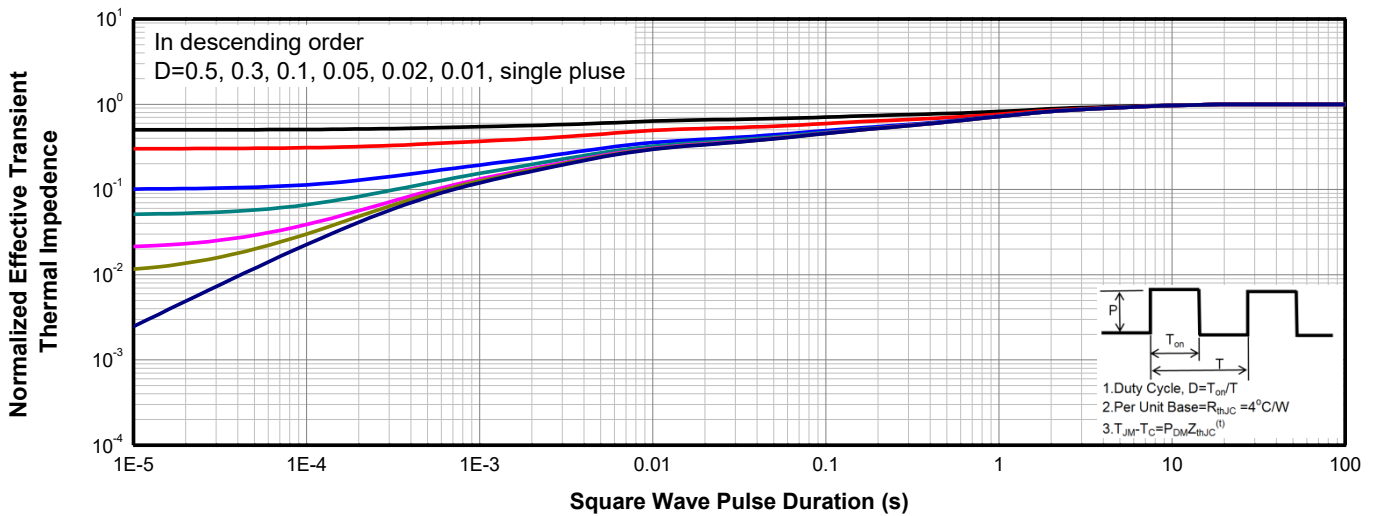
**TO-252E-2**  
Safe operating area(Note D)



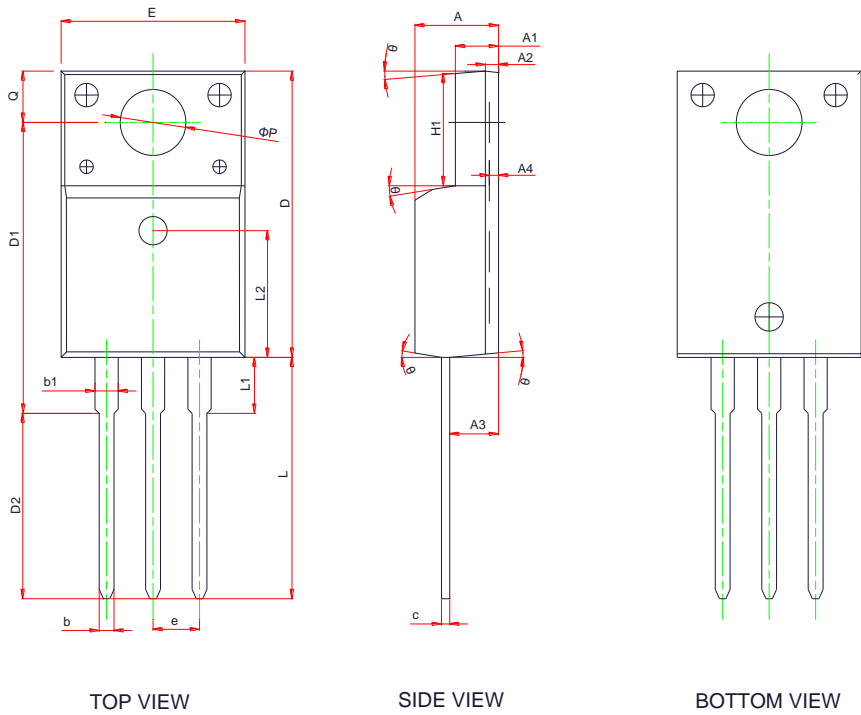
**TO-220F**  
Safe operating area(Note D)



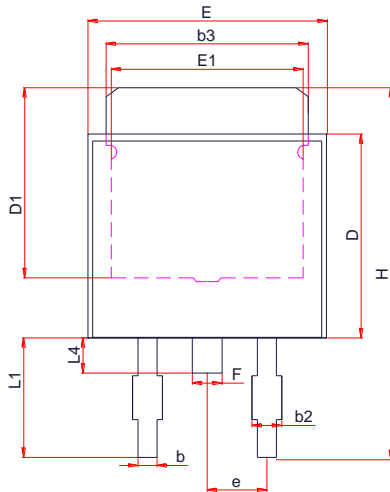
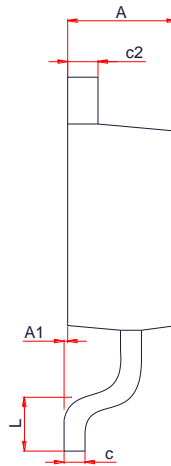
**TO-252E-2 TO-220F Transient thermal response(Junction to case)**



**TO-220F Transient thermal response(Junction to case)(Note D)**

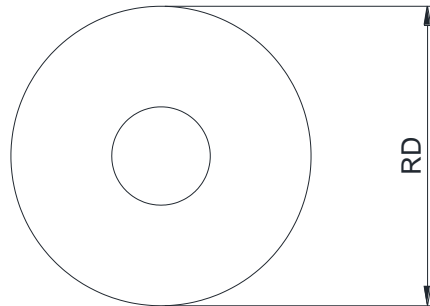
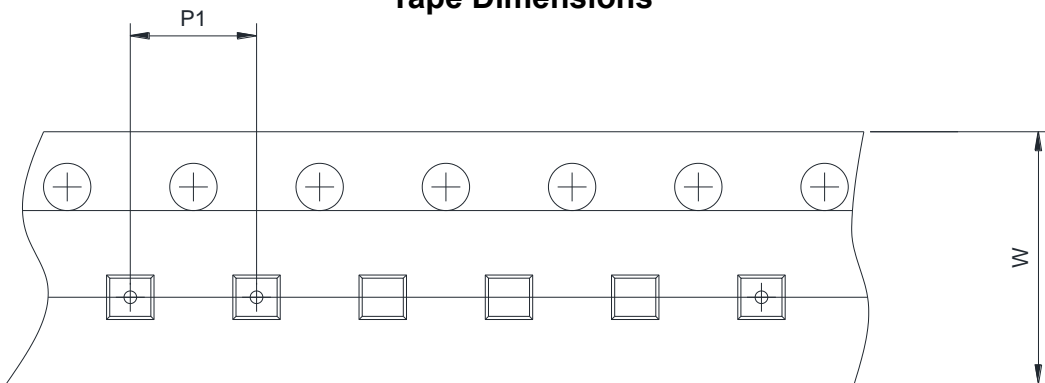
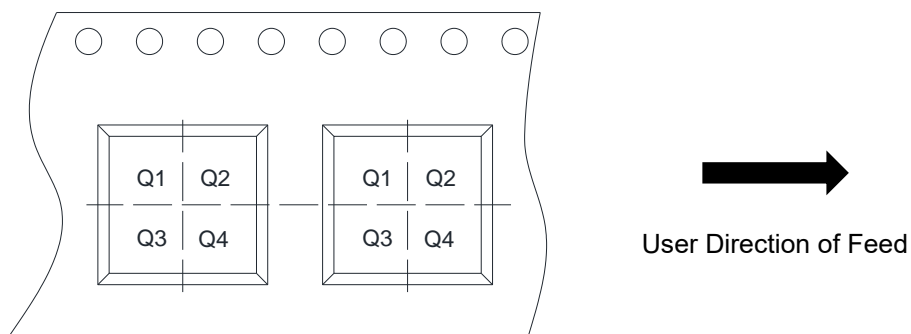
**PACKAGE OUTLINE DIMENSIONS**
**TO-220F-3L**


Symbol	Dimensions in Millimeters		
	Min.	Typ.	Max.
A	4.50	4.72	4.90
A1	2.45	2.56	2.65
A2	0.72Ref		
A3	2.68	2.78	2.88
A4	-	-	0.45
b	0.70	0.80	0.90
b1	1.18	1.28	1.38
c	0.45	0.52	0.60
D	15.67	15.87	16.07
D1	15.55	15.75	15.95
E	9.96	10.16	10.36
e	2.45BSC		
H1	6.48	6.68	6.88
L	12.68	12.98	13.28
L1	-	-	3.50
L2	2.54BSC		
φP	3.08	3.18	3.28
Q	3.20	-	3.40
θ	3°	5°	7°

**PACKAGE OUTLINE DIMENSIONS**
**TO-252E-2L**

**TOP VIEW**

**SIDE VIEW**

**SIDE VIEW**

Symbol	Dimensions in Millimeters		
	Min.	Typ.	Max.
A	2.20	2.30	2.40
A1	0	0.08	0.15
b	0.50	0.60	0.70
b2	0.60	0.75	0.90
b3	5.20	5.35	5.50
c2	0.45	0.50	0.55
c	0.51Ref		
D	5.40	5.60	5.80
D1	4.57	-	-
E	6.40	6.60	6.80
E1	3.81	-	-
e	2.30Ref		
F	0.70	0.80	0.90
H	9.40	9.80	10.20
L	1.40	1.59	1.77
L1	2.40	2.70	3.00
L4	0.80	1.00	1.20

**TAPE AND REEL INFORMATION**
**Reel Dimensions**

**Tape Dimensions**

**Quadrant Assignments For PIN1 Orientation In Tape**


RD	Reel Dimension	<input type="checkbox"/> 7inch	<input checked="" type="checkbox"/> 13inch
W	Overall width of the carrier tape	<input type="checkbox"/> 8mm	<input type="checkbox"/> 12mm <input checked="" type="checkbox"/> 16mm
P1	Pitch between successive cavity centers	<input type="checkbox"/> 2mm	<input checked="" type="checkbox"/> 4mm <input checked="" type="checkbox"/> 8mm
Pin1	Pin1 Quadrant	<input type="checkbox"/> Q1	<input checked="" type="checkbox"/> Q2 <input type="checkbox"/> Q3 <input type="checkbox"/> Q4



制 修 订 记 录					
文件版本	制修日期	修订页次	修订人	变更内容	
Rev. 0.9	20180112	非正式版	衷世雄	非正式版	
Rev.1.0	20180326	正式版	衷世雄	正式版	
Rev1.1	20181008	5	解天赐	热阻	
Rev1.2	20190621	1, 2	衷世雄	Eas	
批准		审核		编制	
日期		日期		日期	
各部门会签					
应用部	封装部	市场部	生产管理部		
市场部上传者/上传时间					
品质部确认者/确认时间					